

### 1.0 SCOPE

This specification documents the detailed requirements for Analog Devices space qualified die including die qualification as described for Class K in MIL-PRF-38534, Appendix C, Table C-II except as modified herein.

The manufacturing flow described in the STANDARD DIE PRODUCTS PROGRAM brochure at <http://www.analog.com/aerospace> is to be considered a part of this specification.

This data sheet specifically details the space grade version of this product. A more detailed operational description and a complete data sheet for commercial product grades can be found at [www.analog.com/OP27](http://www.analog.com/OP27)

### 2.0 Part Number. The complete part number(s) of this specification follow:

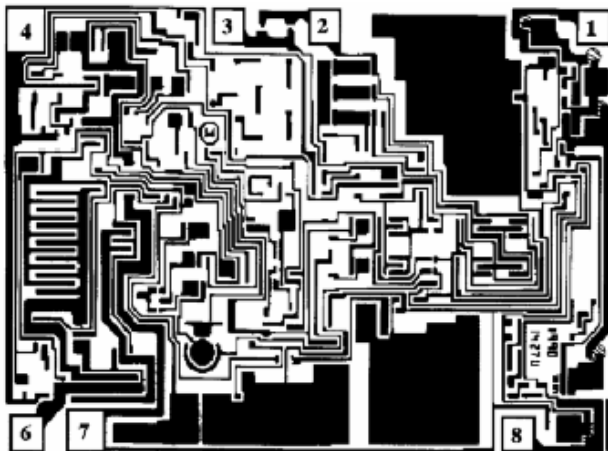
<u>Part Number</u>	<u>Description</u>
OP27-000C	Low-Noise Precision Operational Amplifier
OP27R000C	Radiation Tested Low-Noise Precision Operational Amplifier

### 3.0 Die Information

#### 3.1 Die Dimensions

Die Size	Die Thickness	Bond Pad Metalization
66 mil x 95 mil	19 mil $\pm$ 2 mil	Al/Cu

#### 3.2 Die Picture



1. BALANCE
2. -INPUT
3. +INPUT
4. -Vs
5. NC
6. OUT
7. +Vs
8. BALANCE

ASD0012330

Rev. H

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**3.3 Absolute Maximum Ratings 1/**

Supply Voltage ( $V_S$ ) .....	$\pm 22V$
Input Voltage <u>2/</u> .....	$\pm 22V$
Output Short Circuit Duration .....	Indefinite
Differential Input Voltage <u>3/</u> .....	$\pm 0.7V$
Differential Input Current <u>3/</u> .....	$\pm 25mA$
Storage Temperature Range .....	$-65^{\circ}C$ to $+150^{\circ}C$
Operating Temperature Range .....	$-55^{\circ}C$ to $+125^{\circ}C$
Junction Temperature ( $T_J$ ).....	$150^{\circ}C$

**Absolute Maximum Ratings Notes**

- 1/ Stresses above the absolute maximum rating may cause permanent damage to the device. Extended operation at the maximum levels may degrade performance and affect reliability.
- 2/ For supply voltages less than  $\pm 22V$ , the absolute maximum input voltage is equal to the supply voltages.
- 3/ The device inputs are protected by back-to-back diodes. Current limiting resistors are not used in order to achieve low noise. If differential input voltage exceeds  $\pm 0.7V$ , the input current should be limited to 25mA.

**4.0 Die Qualification**

In accordance with class-K version of MIL-PRF-38534, Appendix C, Table C-II, except as modified herein.

- (a) Qual Sample Size and Qual Acceptance Criteria – 10/0
- (b) Qual Sample Package – DIP
- (c) Pre-screen electrical test over temperature performed post-assembly prior to die qualification.

**Table I - Dice Electrical Characteristics**

Parameter	Symbol	Conditions <u>1/</u>	Limit Min	Limit Max	Units
Input Offset Voltage	$V_{OS}$		-25	25	$\mu\text{V}$
Input Offset Current	$I_{OS}$		-35	+35	nA
Average Input Bias Current	$I_{IB}$		-40	+40	nA
Input Voltage Range	IVR		$\pm 11$		V
Power Supply Rejection Ratio	PSRR	$V_S = \pm 4.5\text{V to } \pm 18\text{V}$		10	$\mu\text{V/V}$
Output Voltage Swing	$V_{OUT}$	$R_L \geq 2\text{k}\Omega$	$\pm 12$		V
		$R_L \geq 600\Omega$	$\pm 10$		
Supply Current	$I_S$	No Load		4.67	mA
Power Dissipation	$P_D$	No Load		140	mW
Output Short-Circuit Current	$+I_{SC}$			+70	mA
	$-I_{SC}$		-70		
Slew Rate	SR	$V_{OUT} = \pm 5\text{V}, R_L \geq 2\text{k}\Omega,$ $C_L = 100\text{pF},$ measured at -2.5V to +2.5V	1.7		$\text{V}/\mu\text{s}$
Gain Bandwidth	GBW		5		MHz
Common Mode Rejection Ratio	CMRR	$V_{CM} = \text{IVR} = \pm 11\text{V}$	114		dB
Large Signal Voltage Gain	$A_{VO}$	$V_{OUT} = \pm 10\text{V}, R_L \geq 2\text{k}\Omega$	1000		$\text{V/mV}$

Table I Notes:

1/  $V_S = \pm 15\text{V}, T_A = 25^\circ\text{C}$ , unless otherwise specified.

Table II - Electrical Characteristics for Qual Samples						
Parameter	Symbol	Conditions <u>1/</u>	Sub- groups	Limit Min	Limit Max	Units
Input Offset Voltage	V <sub>OS</sub>		4	-25	25	μV
			5, 6	-60	60	
			M, D, L, R <u>3/</u>	4	-100	
Average Input Offset Voltage <u>2/</u>	TCV <sub>OS</sub>		5, 6	-0.6	0.6	μV/°C
Input Offset Current	I <sub>OS</sub>		1	-35	+35	nA
			2, 3	-50	+50	
			M, D, L, R <u>3/</u>	1	-100	
Average Input Bias Current	I <sub>IB</sub>		1	-40	+40	
			2, 3	-60	+60	
			M, D, L, R <u>3/</u>	1	-1000	
Input Voltage Range <u>2/</u>	IVR		1	±11		V
			2, 3	±10.3		
Power Supply Rejection Ratio <u>2/</u>	PSRR	V <sub>S</sub> = ±4.5V to ±18V	1		10	μV/V
			2, 3		16	
Output Voltage Swing <u>2/</u>	V <sub>OUT</sub>	R <sub>L</sub> ≥ 2kΩ	1	±12		V
		R <sub>L</sub> ≥ 600Ω		±10		
		R <sub>L</sub> ≥ 2kΩ	2, 3	±11.5		
Supply Current	I <sub>S</sub>	No Load	1		4.67	mA
		M, D, L, R <u>3/</u>	1		4.7	
Power Dissipation <u>2/</u>	P <sub>D</sub>	No Load	1		140	mW
Output Short-Circuit Current <u>2/</u>	+I <sub>SC</sub>		1		+70	mA
	-I <sub>SC</sub>			-70		
Slew Rate <u>2/</u>	SR	V <sub>OUT</sub> = ±5V, R <sub>L</sub> ≥ 2kΩ, C <sub>L</sub> = 100pF, measured at -2.5V to +2.5V	4	1.7		V/μs
Gain Bandwidth <u>2/</u>	GBW		4	5		MHz
Common Mode Rejection Ratio <u>2/</u>	CMRR	V <sub>CM</sub> = IVR = ±11V	4	114		dB
		V <sub>CM</sub> = IVR = ±10.3V	5, 6	108		
Large Signal Voltage Gain	A <sub>VO</sub>	V <sub>OUT</sub> = ±10V, R <sub>L</sub> ≥ 2kΩ	4	1000		V/mV
			5, 6	600		
			M, D, L, R <u>3/</u>	4	100	

Table II Notes:

- 1/ V<sub>S</sub> = ±15V, R<sub>S</sub> = 50Ω, unless otherwise specified.
- 2/ This parameter not tested post irradiation.
- 3/ Devices tested at 100Krad irradiation.

**Table III - Life Test Endpoint and Delta Parameter**  
**(Product is tested in accordance with Table II with the following exceptions)**

Parameter	Symbol	Sub-groups	Post Burn In Limit		Post Life Test Limit		Life Test Delta	Units
			Min	Max	Min	Max		
Input Offset Voltage	V <sub>OS</sub>	4	-60	60	-135	135	±75	μV
		5, 6			-170	170		
Input Bias Current	I <sub>IB</sub>	1	-55	55	-65	65	±10	nA
		2, 3			-85	85		

## 5.0 Life Test/Burn-In Information

- 5.1 HTRB is not applicable for this drawing.
- 5.2 Burn-in is per MIL-STD-883 Method 1015 test condition B or C.
- 5.3 Steady state life test is per MIL-STD-883 Method 1005.

Rev	Description of Change	Date
A	Initiate	5-Jun-091
B	Delete post burn-in temp limit from Table III; Add Document Number and Absolute Max Ratings	265-Jun-091
C	Delete VOS adjust from Table I and II, Delete 600ohm gain, change PSRR range from $\pm 4V$ to $\pm 18V$ to $\pm 4.5V$ to $\pm 18V$ . Update web address.	20-Dec-01
D	Update web address	Aug. 5, 2003
E	Add radiation limits and part number for rad guarantee.	Sept. 30, 2003
F	Update header/footer and add to 1.0 Scope description.	Feb. 26, 2008
G	Add Junction Temperature(TJ)...150°C to 3.3 Absolute Max Ratings	March 27, 2008
H	Updated Section 4.0c note to indicated pre-screen temp testing being performed.	June 6, 2009